

TRADEMARK ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	RELEASE BY SECURED PARTY

CONVEYING PARTY DATA

Name	Formerly	Execution Date	Entity Type
CITICORP NORTH AMERICA, INC., AS AGENT		11/28/2005	CORPORATION: DELAWARE

RECEIVING PARTY DATA

Name:	AMKOR TECHNOLOGY, INC.
Street Address:	1900 SOUTH PRICE ROAD
City:	CHANDLER
State/Country:	ARIZONA
Postal Code:	85248
Entity Type:	CORPORATION: DELAWARE

PROPERTY NUMBERS Total: 19

Property Type	Number	Word Mark
Registration Number:	1241384	AMKOR
Registration Number:	1396071	AMKOR ANAM
Registration Number:	2478303	AMKOR TECHNOLOGY
Registration Number:	2478315	AMKOR TECHNOLOGY
Registration Number:	2159448	CHIPARRAY
Registration Number:	2505797	CHIPARRAY
Registration Number:	2762388	ENABLING A MICROELECTRONIC WORLD
Registration Number:	2145506	FLEXBGA
Registration Number:	1754474	POWERQUAD
Registration Number:	2118551	POWERSOP
Registration Number:	2528886	POWERSOP
Registration Number:	1866256	SUPERBGA
Registration Number:	2568521	TAPEARRAY

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Registration Number:	2393904	VISIONPAK
Serial Number:	76145468	ETCSP
Serial Number:	75577326	MICROLEADFRAME
Serial Number:	76107763	MLF
Serial Number:	76145559	MLFLEX
Serial Number:	76145560	SUPERFC

CORRESPONDENCE DATA

Fax Number: (214)855-4300
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.
Phone: 214-855-4731
Email: awalker@jenkens.com
Correspondent Name: Cathryn A. Berryman, Jenkens & Gilchrist
Address Line 1: 1445 Ross Avenue
Address Line 2: Suite 3700
Address Line 4: Dallas, TEXAS 75202-2799

ATTORNEY DOCKET NUMBER:	46715-1296
NAME OF SUBMITTER:	CATHRYN A. BERRYMAN
Signature:	/Cathryn A. Berryman/
Date:	12/02/2005

Total Attachments: 6
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TERMINATION AND RELEASE
OF
TRADEMARK SECURITY AGREEMENT

TERMINATION AND RELEASE OF TRADEMARK SECURITY AGREEMENT, dated as of November ~~28~~, 2005 (this "Termination and Release"), by Citicorp North America, Inc. ("CNAI"), as agent for the Secured Parties (in such capacity, the "Administrative Agent" and "Grantee") under that certain Credit Agreement, dated as of June 29, 2004 (as amended up to the date hereof, the "Credit Agreement"), among Amkor Technology, Inc. (the "Borrower"), the Lenders and Issuers party thereto and the Administrative Agent. Capitalized terms used but not otherwise defined herein shall have the meanings ascribed thereto in the Credit Agreement.

WHEREAS, pursuant to that certain Trademark Security Agreement, dated as of June 29, 2004 (as amended up to the date hereof, the "IP Security Agreement"), by the Borrower and the other grantors party thereto (collectively, the "Grantors"), each Grantor granted to the Grantee a security interest in, and granted, assigned and conveyed to the Grantee, such Grantor's entire right, title and interest in and to the Trademarks and Trademark Licenses, including without limitation, all marks and related applications and registrations thereto, and all reissues, continuations, and extensions thereof, and appurtenant goodwill of any and all of the foregoing, set forth in the IP Security Agreement, including without limitation the Intellectual Property listed on Exhibit A hereto (the "IP Collateral"); and

WHEREAS, in consideration of its receipt of full payment of amounts due under the Credit Agreement, the Grantee has terminated the IP Security Agreement and agreed to release, relinquish and discharge its entire right, title and interest in and to the IP Collateral as herein provided;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the Grantee hereby agrees as follows:

1. The Grantee hereby releases, relinquishes, terminates and discharges in its entirety the security interest that it has against any and all right title and interest that it has acquired in and to, the IP Collateral, together with any interest in all goodwill of the business connected with the use of, and symbolized by, the IP Collateral, and all products and proceeds of the foregoing, including without limitation, any claim by the Borrower against third parties for past, present or future infringement or dilution or any trademark or injury to the goodwill associated with any and all of the foregoing, in the United States of America and all other countries of the world.

2. The Grantee hereby agrees, at the expense of the Borrower, to take any reasonable actions and to execute any further documents necessary or reasonably requested by the Borrower to effectuate, record or evidence the release of the Grantee's security interest in the IP Collateral.

3. The Grantee authorizes and requests the United States Patent and Trademark Office to record this Termination and Release against the IP Collateral. The Grantee authorizes the Borrower (and its representatives and agents) to record this Termination and Release against the IP Collateral with the appropriate agency of any other countries in which the Grantee has a security interest in and to the IP Collateral.

4. This Termination and Release shall be governed by the law of the State of New York.

[Signature page follows]

IN WITNESS WHEREOF, the Grantee has caused this Termination and Release to be duly executed as of this 28 day of November, 2005.

CITICORP NORTH AMERICA, INC.,
as Grantee

By: *Suzanne Crymes*
Name: SUZANNE CRYMES
Title: Vice President

Exhibit A
IP Collateral

See attached.

Schedule I

Trademarks

SMMF&F Ref. No.	Mark	Serial/Reg. No.	Filing/Issue Date
TM-1628-SM US	AMKOR	73/327,747 1241384	9/14/81
TM-1629-SM US	AMKOR ANAM (AND DESIGN)	73/492,203 1396071	7/30/84
TM-1300i US	AMKOR TECHNOLOGY	75/417,622 Reg. 2,478,303	1/13/98 Reg. 8/14/01
TM-1503i US	AMKOR TECHNOLOGY (AND DESIGN)	75/454,796 Reg. #2,478,315	3/23/98 Reg. 8/14/01
TM-1022i US	CHIPARRAY	75/105,481 2159448 Reg. #2,505,797	5/16/96 Reg. 11/13/01
388.009	ENABLING A MICROELECTRONIC WORLD	In Progress	-
TM-1961i US	ETCSP	76/145,468	11/11/00
TM-1621 US	FLEXBGA (Stylized)	75/199,920 Reg. #2,145,506	11/19/96 Reg. 3/17/98
TM-1625i US	MICROLEADFRAME (STYLIZED)	75/577,326	10/27/98
TM-1890i US	MLF	76/107,763	8/10/00
TM-1963i US	MLFLEX	76/145,559	10/11/00
TM-1517i US	POWERQUAD	74/207,880 Reg. #1,754,474	9/30/91 Reg. 2/23/93
TM-1023i US	POWERSOP	75/105,480 Reg. #2,118,551 Reg. #2,528,886	5/16/96 Reg. 12/2/97 Reg. 1/15/02
TM-1519i US	SUPERBGA	74/347,349 Reg. #1,866,256	1/11/93 Reg. 12/6/94
TM-1968i US	SUPERFC	76/145,560	10/11/00
TM-1624i US	TAPE ARRAY (STYLIZED)	75/573,579 Reg. #2,568,521	10/19/98 Reg. 5/7/02

TM-1316i US	VISIONPAK	75/428,175 Reg. #2,393,904	2/3/98 Reg. 10/10/00
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